

NCE N-Channel Enhancement Mode Power MOSFET

Description

The NCE6045XG uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

100% UIS TESTED! 100% ΔVds TESTED!

General Features

- V_{DS} =60V, I_D =45A $R_{DS(ON)}$ =7.4m Ω (typical) @ V_{GS} =10V
 - $R_{DS(ON)}$ =11.4m Ω (typical) @ V_{GS} =4.5V
- High density cell design for ultra low Rdson
- Very low on-resistance R_{DS(on)}
- Good stability and uniformity with high E_{AS}
- 150 °C operating temperature
- Pb-free lead plating

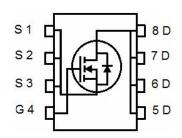
DFN 5X6





Top View

Bottom View



Schematic Diagram

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size Tape widt		Quantity
NCE6045XG	NCE6045XG	DFN5X6-8L	Ø330mm	12mm	5000

Absolute Maximum Ratings (T_c=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	VDS	60	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	I _D	45	А
Drain Current-Continuous(T _C =100 ℃)	I _D (100℃)	32	А
Pulsed Drain Current	I _{DM}	140	А
Single pulse avalanche energy (Note 5)	Eas	260	mJ
Maximum Power Dissipation	P _D	60	W
Operating Junction and Storage Temperature Range	T_{J}, T_{STG}	-55 To 150	$^{\circ}$ C

Thermal Characteristic

Thermal Resistance, Junction-to-Case ^(Note 2)	ReJC	2.08	°C/W

Electrical Characteristics (T_C=25 °C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	60		-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =60V,V _{GS} =0V	-	-	1	μΑ
Gate-Body Leakage Current	I _{GSS}	V_{GS} =±20 V , V_{DS} =0 V	-	-	±100	nA
On Characteristics (Note 3)	·					
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS},I_{D}=250\mu A$	1.2	1.9	2.5	V
Dunin Course On State Besistance	D.	V _{GS} =10V, I _D =20A	-	7.4	9	mΩ
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =4.5V, I _D =20A	-	11.4	14	mΩ
Forward Transconductance	G FS	V _{DS} =5V,I _D =20A	25	-	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C _{lss}		-	2750	-	PF
Output Capacitance	Coss	$V_{DS}=30V, V_{GS}=0V,$	-	170	-	PF
Reverse Transfer Capacitance	C _{rss}	F=1.0MHz	-	152	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t _{d(on)}		-	9	-	nS
Turn-on Rise Time	tr	V_{DD} =30 V , R_L =1.5 Ω	-	7	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10 V , R_{GEN} =3 Ω	-	32	-	nS
Turn-Off Fall Time	t _f		-	6	-	nS
Total Gate Charge	Qg	.,	-	60	-	nC
Gate-Source Charge	Q _{gs}	V_{DS} =30V, I_{D} =20A,	-	10	-	nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V	-	14	-	nC
Drain-Source Diode Characteristics	,		•			
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =20A	-	-	1.2	V
Diode Forward Current (Note 2)	Is		-	-	45	Α
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF=20A	-	31	-	nS
Reverse Recovery Charge	Qrr	$di/dt = 100A/\mu s^{(Note3)}$	-	45	-	nC

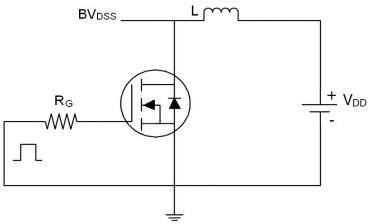
Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board, $t \le 10$ sec.
- **3.** Pulse Test: Pulse Width ≤ 300μ s, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production
- **5.**E_{AS} condition: Tj=25 $^{\circ}$ C,V_{DD}=30V,V_G=10V,L=0.5mH,Rg=25 Ω

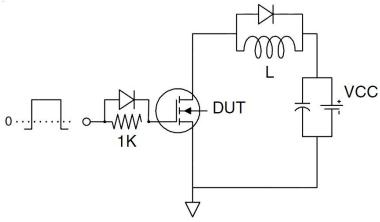


Test Circuit

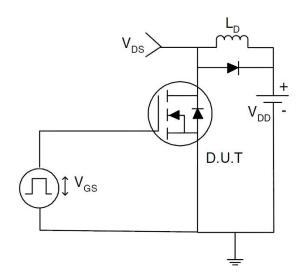
1) E_{AS} test Circuit



2) Gate charge test Circuit



3) Switch Time Test Circuit





Typical Electrical and Thermal Characteristics (Curves)

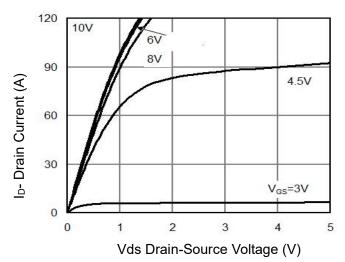


Figure 1 Output Characteristics

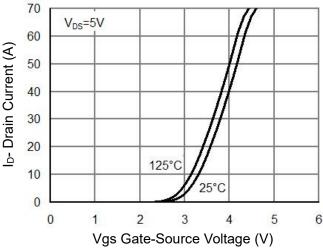


Figure 2 Transfer Characteristics

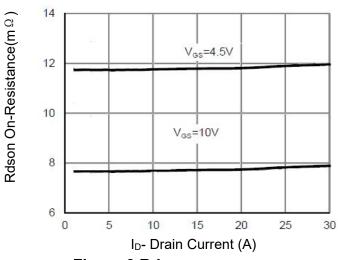


Figure 3 Rdson- Drain Current

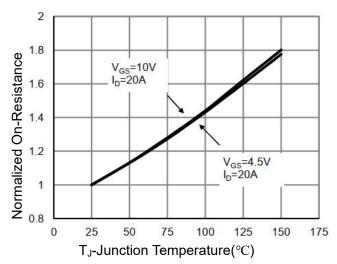


Figure 4 Rdson-JunctionTemperature

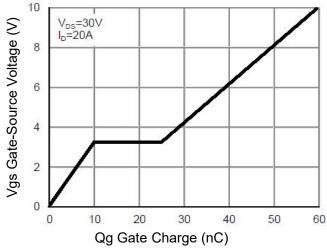


Figure 5 Gate Charge

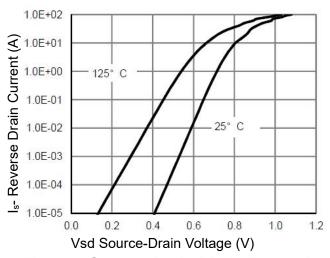


Figure 6 Source- Drain Diode Forward



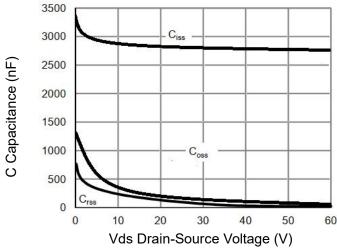


Figure 7 Capacitance vs Vds

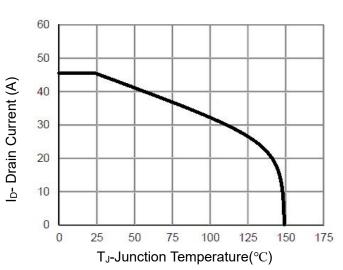


Figure 9 Current De-rating

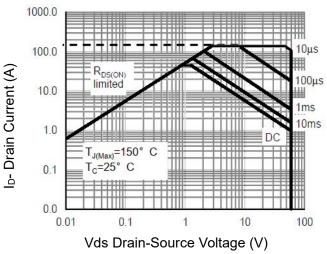


Figure 8 Safe Operation Area

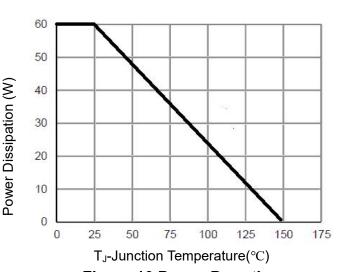
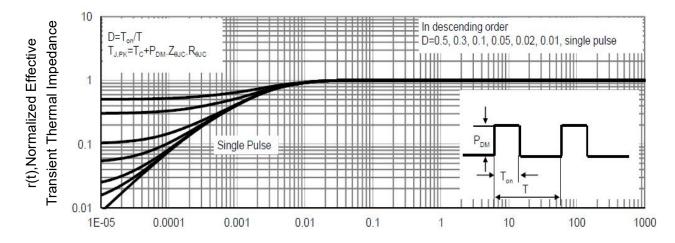


Figure 10 Power De-rating

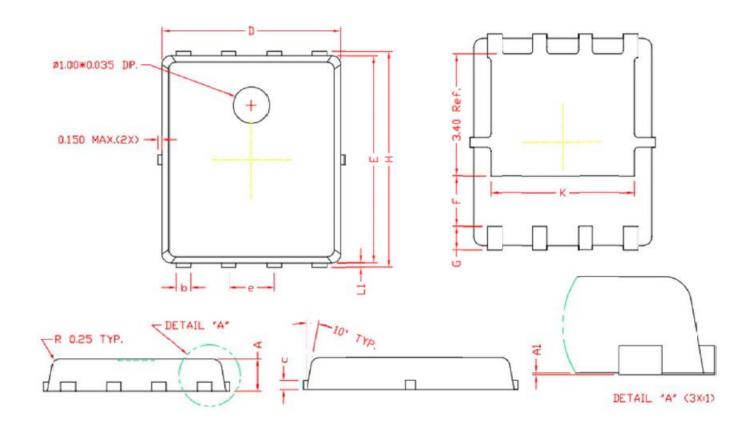


Square Wave Pluse Duration(sec)

Figure 11 Normalized Maximum Transient Thermal Impedance



DFN5X6-8L Package Information



COMMON DIMENSIONS

(UNITS OF MEASURE=MILLIMETER)

SYMBOL	MIN	NOM	MAX		
A	0.80	0.90	1.00		
A1	0.00	0.03	0.05		
b	0.35	0.42	0.49		
С	0. 254 REF.				
D	4.90	5.00	5. 10		
F	1.40 REF.				
E	5.70	5.80	5. 90		
е	1. 27 BSC.				
Н	5.95	6.08	6. 20		
L1	0.10	0.14	0.18		
G	0.60 REF.				
K	4.00 REF.				



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